



DUAL SURFACE MOUNT SWITCHING DIODE

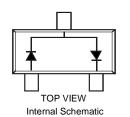
Features

- Fast Switching Speed: Maximum of 4ns
- Low Total Capacitance: Maximum of 2pF
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208 (3)
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)





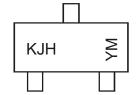
Ordering Information (Note 4)

Part Number	Case	Packaging
MMBD7000-7-F	SOT23	3000/Tape & Reel

Notes:

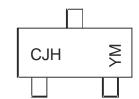
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



K = SAT (Shanghai Assembly / Test site) JH = Product Type Marking Code YM = Date Code Marking

Y = Year ex: Z = 2012 M = Month ex: 9 = September



C = CAT (Chengdu Assembly / Test site)
JH = Product Type Marking Code
YM = Date Code Marking
Y = Year ex: Z = 2012
M = Month ex: 9 = September

Date Code Key

Year	1999	2000	2001	2002	2003		2018	2019	2021	2022	2023	2024	2025	2026
Code	K	L	М	N	Р		F	G	Н	1	J	K	L	М
Month	Jan	Feb	Ма	ır /	Apr	May	Jun	Jul	Aug	Se	p	Oct	Nov	Dec
Code	1	2	3		4	5	6	7	8	9)	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage		V _{RRM} V _{RWM}	75	V
Forward Continuous Current (Note 5)		I _{FM}	300	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	2.0 1.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\Theta JA}$	357	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

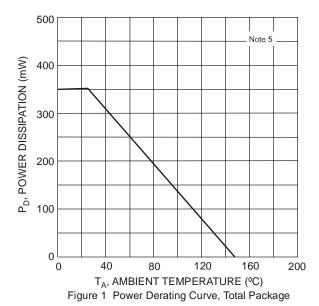
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	75	_	V	$I_R = 100 \mu A$
Forward Voltage	V _F	0.55 0.67 0.75 —	0.70 0.82 1.10 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 6)	I _R	_	1.0 3.0 100 25	μΑ μΑ μΑ nA	$V_R = 50V$ $V_R = 100V$ $V_R = 50V, T_J = +125^{\circ}C$ $V_R = 20V$
Total Capacitance	Ст	_	2.0	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

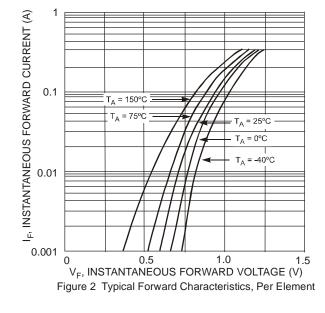
Notes:

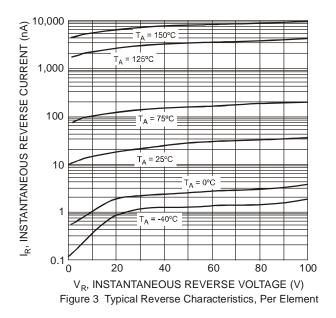
^{5.} Part mounted on FR-4 substrate printed circuit board with 1 inch square 2oz copper pad area.

^{6.} Short duration pulse test used to minimize self-heating effect.









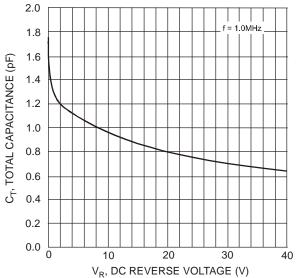
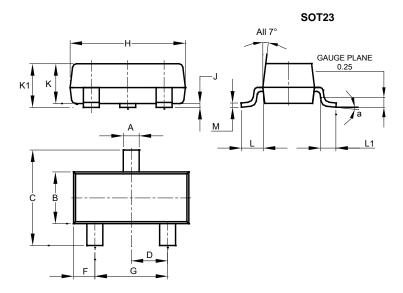


Figure 4 Total Capacitance vs. Reverse Voltage, Per Element



Package Outline Dimensions

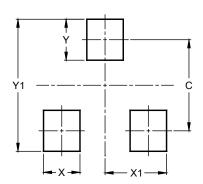
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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5 of 5 MMBD7000 May 2019 © Diodes Incorporated Document number: DS12025 Rev. 10 - 2

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